

Test vehicle for studying thermal conductivity of die attach adhesives for high temperature electronics

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Outline

1 Introduction

2 Test Vehicle

3 System Model

4 Results

5 Conclusions

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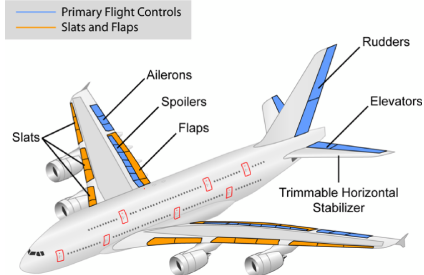
4 Results

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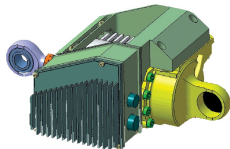
All Electric Aircraft Concept

- Removal of all Aircraft hydraulic and Pneumatic systems
- All are replaced with Electro-Mechanical Actuators (EMAs)
- Engines to supply **Propulsion** and **Electricity** only

<http://i15.photobucket.com/albums/a357/thezeke/A380%20systems/6046001.png>



- Necessity for **high temperature electronics**
- High reliability, **high temperature packaging**



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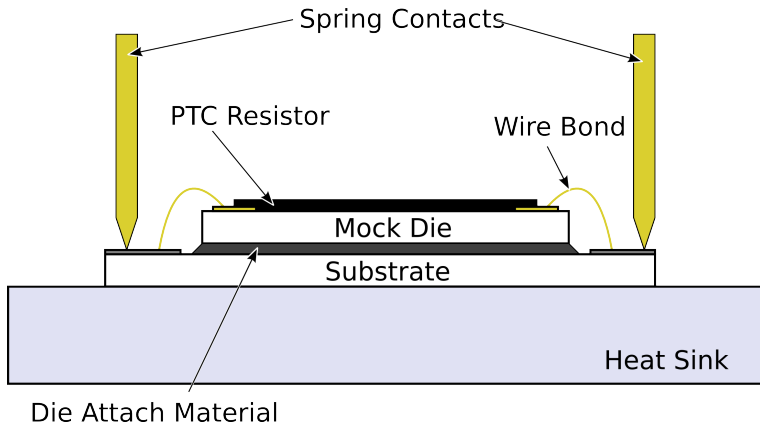
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Test Rig



Test vehicle
for studying
thermal
conductivity

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Introduction

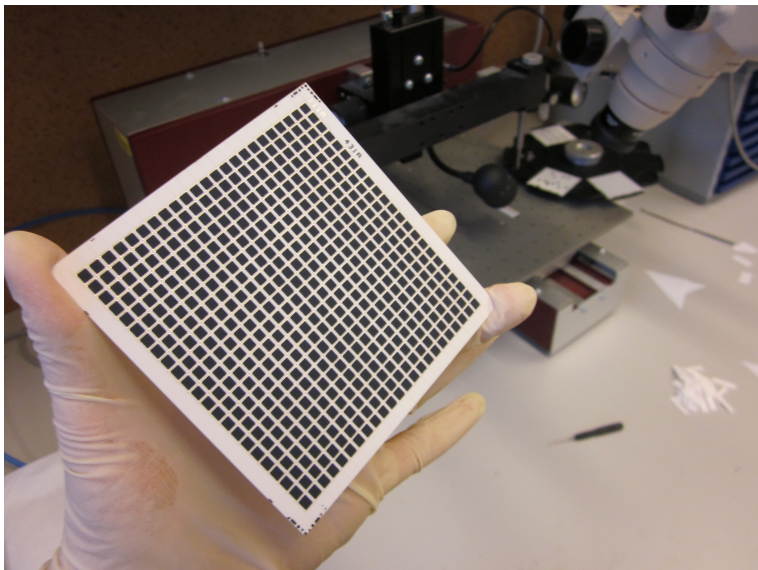
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System Model

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Mock Dies



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Assembling Test Vehicle

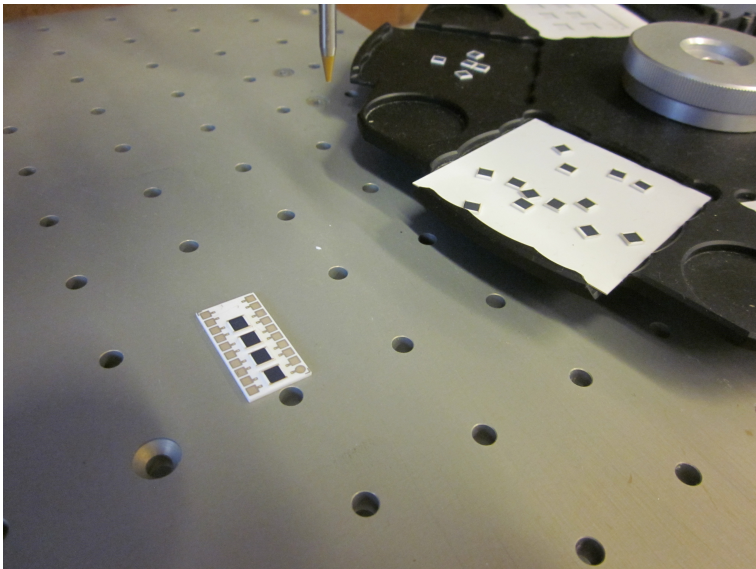
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① Introduction

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③ System Model

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- Heat capacity of die
- Thermal conductivity of die attach
- Dynamic model describing temperature decay
- Describes a system that **decays exponentially**

System model

$$\Delta T = \frac{Q}{S} \quad (1)$$

$$\Delta T = \frac{-L}{kA} q \quad (2)$$

$$\frac{-L}{kA} q - \frac{Q}{S} = 0 \quad (3)$$

$$\Delta T = \Delta T_0 e^{\frac{-kA}{LS} t} \quad (4)$$

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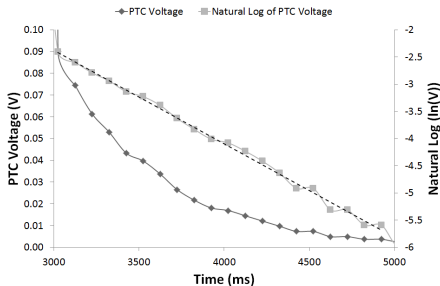
③ System Model

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Output

- Decay in temperature is **exponential**
- Shows good **agreement** with the model



- Time constants measured (0.55, 0.72, 0.62, 0.61, and 0.66 seconds) for each die

Thermal Conductivity Estimation

$$\tau = \frac{kA}{LS} \quad (5)$$

- $L = 50 \mu m$

- $A = 16 mm^2$

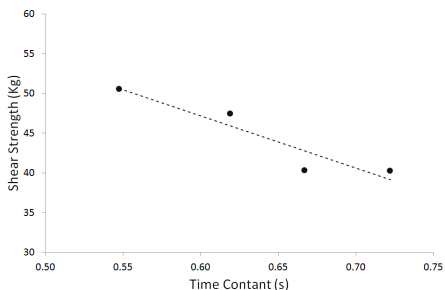
$$k = \frac{LS\tau}{A} \quad (6)$$

- $S = 27.2 \times 10^{-3} \frac{J}{K}$

- Thermal conductivity calculated (0.15, 0.12, 0.14, 0.14 and $0.13 \frac{W}{mK}$) for each die
- STYCAST 2741 — $0.33 \frac{W}{mK}$

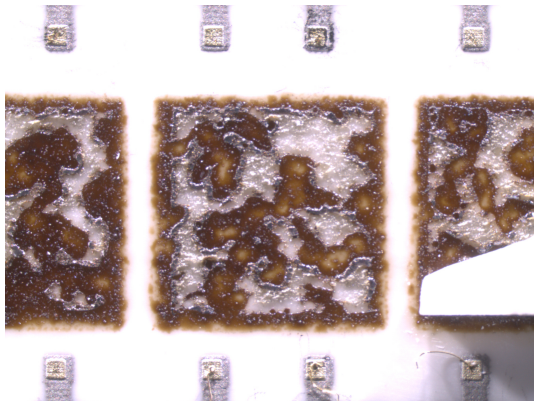
- Shear strength test **can be used in conjunction** with this method
- Here decreased **time constant** has an increased **shear strength**

Shear Strength



Visual Inspection

- Shows that **voids** were present under the die
- Leading to a **reduction** in thermal conductivity



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- Test Vehicle and Test Rig constructed
- Model developed showing good correlation with output
- Thermal conductivity could be estimated
- Shear strength test and inspection under microscope performed

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Thank you for your attention



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